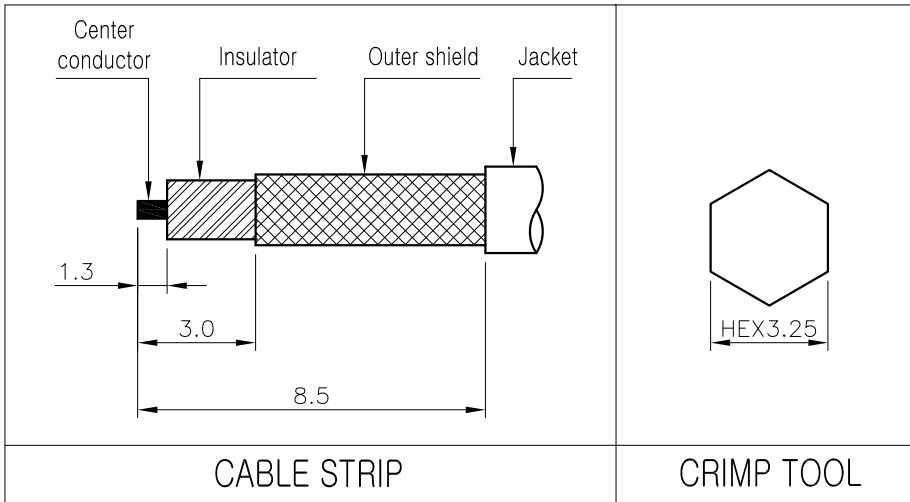
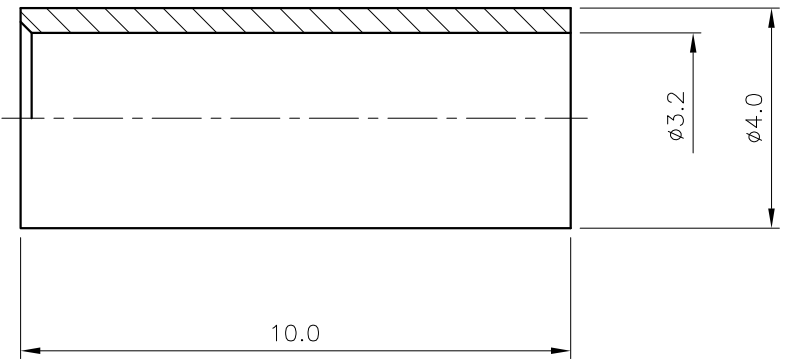
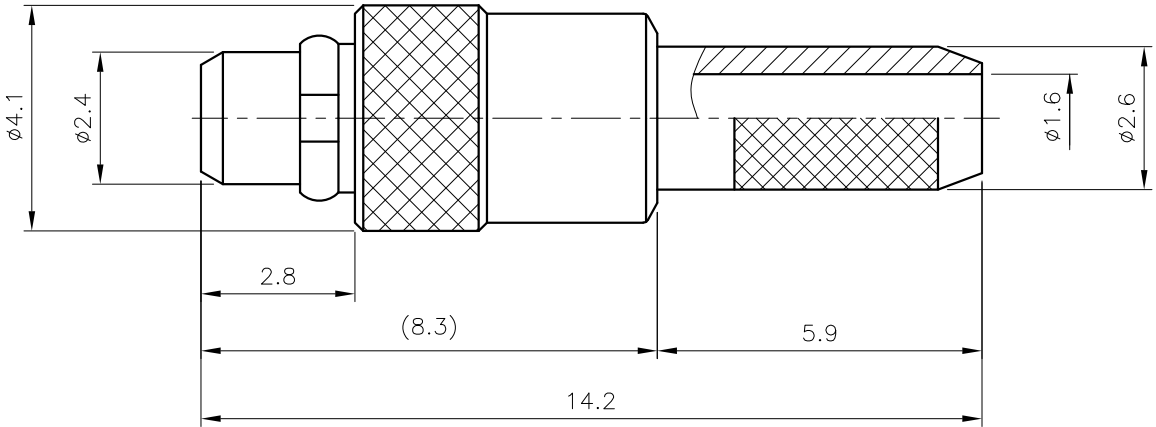


REVISION						
REV	DESCRIPTION			DRAWN	APPR	DATE
IR	Initial Registration					2020.02.23.
1	설변처리No.202203-0008 PIPE 하판변화 부품 적용으로 인한 코드 변경			S.Y.EUN	S.H.KIM	2022.03.14.
2	가시미 부위 치수 변경			S.H.KIM		2023.02.27.



6	SPRING RING	1	BeCu C17300	Gold Plate	DSR00001-5/1
5	INSULATOR	1	TEFLON		DIN00012-N/1
4	FERRULE	1	MBsBD C3604BD-F	Nickel Plate	DFE00034-5/1
3	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT00011-5/1
2	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD01282-5/1
2	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD00011-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.1	DATE 2023. 02. 27.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017 KJ COMTECH CO.,LTD.		
	Angle ±1°	APPROVED BY					
MATERIAL _____		CHECKED BY			TITLE MMCX50 CABLE PS RG316		
		DRAWN BY		S.H.KIM			
FINISH _____		SCALE 7/1	UNIT mm		A4	DWG NO. CN00003-7/1	
						REVISION 2	SHEET 1 of 1